

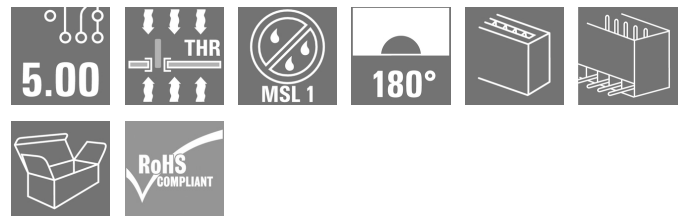
SL-SMT 5.00HC/24/180G 3.2SN BK BX**Weidmüller Interface GmbH & Co. KG**

Klingenbergstraße 26

D-32758 Detmold

Germany

www.weidmueller.com

Product image

High-temperature-resistant pin header, packed in box or tape. On tape, with 1.5 mm solder pin, optimised for automatic assembly. 3.2 mm solder pin suitable for reflow and wave soldering. The pin headers provide space for labelling and can be coded. HC = High Current.

General ordering data

Version	PCB plug-in connector, male header, closed side, THT/THR solder connection, 5.00 mm, Number of poles: 24, 180°, Solder pin length (l): 3.2 mm, tinned, black, Box
Order No.	1841380000
Type	SL-SMT 5.00HC/24/180G 3.2SN BK BX
GTIN (EAN)	4032248352289
Qty.	20 pc(s).
Product data	IEC: 400 V / 27.5 A UL: 300 V / 18.5 A
Packaging	Box

Creation date May 11, 2025 7:36:52 PM CEST

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Technical data**Dimensions and weights**

Depth	8.5 mm	Depth (inches)	0.335 inch
Height	15.2 mm	Height (inches)	0.598 inch
Height of lowest version	12 mm	Width	123.2 mm
Width (inches)	4.85 inch	Net weight	10.65 g

System specifications

Product family	OMNIMATE Signal - series BL/SL 5.00	Type of connection	Board connection
Mounting onto the PCB	THT/THR solder connection	Pitch in mm (P)	5 mm
Pitch in inches (P)	0.197 "	Outgoing elbow	180°
Number of poles	24	Number of solder pins per pole	1
Solder pin length (l)	3.2 mm	Solder pin length tolerance	+0.1 / -0.2 mm
Solder pin dimensions	d = 1.2 mm, Octagonal	Solder pin dimensions = d tolerance	0 / -0.03 mm
Solder eyelet hole diameter (D)	1.5 mm	Solder eyelet hole diameter tolerance (D)	+ 0.1 mm
L1 in mm	115 mm	L1 in inches	4.528 "
Number of rows	1	Pin series quantity	1
Touch-safe protection acc. to DIN VDE 57 106	finger-safe unplugged/ back-of-hand-safe plugged	Touch-safe protection acc. to DIN VDE 0470	IP20 plugged/ IP10 unplugged
Protection degree	IP20	Volume resistance	≤5 mΩ
Can be coded	Yes	Plugging force/pole, max.	7 N
Pulling force/pole, max.	5.5 N		

Material data

Insulating material	LCP GF	Colour	black
Colour chart (similar)	RAL 9011	Insulating material group	IIla
Comparative Tracking Index (CTI)	≥ 175	Moisture Level (MSL)	1
UL 94 flammability rating	V-0	Contact material	Cu-alloy
Contact surface	tinned	Layer structure of solder connection	1...3 µm Ni / 2...4 µm Sn matt
Layer structure of plug contact	1...3 µm Ni / 2...4 µm Sn matt	Storage temperature, min.	-40 °C
Storage temperature, max.	70 °C	Operating temperature, min.	-50 °C
Operating temperature, max.	100 °C	Temperature range, installation, min.	-30 °C
Temperature range, installation, max.	100 °C		

Rated data acc. to IEC

tested acc. to standard	IEC 60664-1, IEC 61984	Rated current, min. number of poles (Tu=20°C)	27.5 A
Rated current, max. number of poles (Tu=20°C)	19 A	Rated current, min. number of poles (Tu=40°C)	24 A
Rated current, max. number of poles (Tu=40°C)	16.5 A	Rated voltage for surge voltage class / pollution degree II/2	400 V
Rated voltage for surge voltage class / pollution degree III/2	320 V	Rated voltage for surge voltage class / pollution degree III/3	250 V
Rated impulse voltage for surge voltage class/ pollution degree II/2	4 kV	Rated impulse voltage for surge voltage class/ pollution degree III/2	4 kV
Rated impulse voltage for surge voltage class/ contamination degree III/3	4 kV		

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Technical data**Rated data acc. to CSA**

Institute (CSA)



Certificate No. (CSA)

200039-1176845

Rated voltage (Use group B / CSA) 300 V

Rated voltage (Use group D / CSA) 300 V

Rated current (Use group B / CSA) 15 A

Rated current (Use group D / CSA) 15 A

Reference to approval values
Specifications are maximum values, details - see approval certificate.**Rated data acc. to UL 1059**

Institute (UR)



Certificate No. (UR)

E60693

Rated voltage (Use group B / UL 1059) 300 V

Rated voltage (Use group D / UL 1059) 300 V

Rated current (Use group B / UL 1059) 18.5 A

Rated current (Use group D / UL 1059) 10 A

Reference to approval values
Specifications are maximum values, details - see approval certificate.**Packing**

Packaging Box

VPE length 150 mm

VPE width 130 mm

VPE height 30 mm

Classifications

ETIM 6.0 EC002637

ETIM 7.0 EC002637

ETIM 8.0 EC002637

ETIM 9.0 EC002637

ETIM 10.0 EC002637

ECLASS 9.0 27-44-04-02

ECLASS 9.1 27-44-04-02

ECLASS 10.0 27-44-04-02

ECLASS 11.0 27-46-02-01

ECLASS 12.0 27-46-02-01

ECLASS 13.0 27-46-02-01

ECLASS 14.0 27-46-02-01

ECLASS 15.0 27-46-02-01

Environmental Product Compliance

RoHS Compliance Status Compliant without exemption

REACH SVHC No SVHC above 0.1 wt%

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Technical data

Important note

IPC conformity	Conformity: The products are developed, manufactured and delivered according international recognized standards and norms and comply with the assured properties in the data sheet resp. fulfill decorative properties in accordance with IPC-A-610 "Class 2". Further claims on the products can be evaluated on request.
Notes	• Gold-plated contact surfaces on request • Rated current related to rated cross-section & min. No. of poles. • Diameter of solder eyelet $D = 1.4 \pm 0.1 \text{ mm}$ • Solder eyelet diameter $D = 1.5 \pm 0.1 \text{ mm}$, from 9 poles • P on drawing = pitch • Rated data refer only to the component itself. Clearance and creepage distances to other components are to be designed in accordance with the relevant application standards. • In accordance with IEC 61984, OMNIMATE-connectors are connectors without breaking capacity (COC). During designated use, connectors are not allowed to be engaged or disengaged when live or under load • Long term storage of the product with average temperature of 50 °C and maximum humidity 70%, 36 months

Approvals

Approvals



Approvals MAMID	https://mdcop.weidmueller.com/mediadelivery/rendition/900_319226/-T1z1mm-S800/ https://mdcop.weidmueller.com/mediadelivery/rendition/900_319262/-T1z1mm-S800/
ROHS	Conform
UL File Number Search	UL Website
Certificate No. (UR)	E60693

Downloads

Approval/Certificate/Document of Conformity	Declaration of the Manufacturer
Engineering Data	CAD data – STEP
Catalogues	Catalogues in PDF-format
Brochures	FL DRIVES EN MB SMT EN FL DRIVES DE MB DEVICE MANUF. EN FL BUILDING SAFETY EN FL APPL LED LIGHTING EN FL INDUSTR.CONTROLS EN FL MACHINE SAFETY EN FL HEATING ELECTR EN FL APPL INVERTER EN FL BASE STATION EN FL ELEVATOR EN FL POWER SUPPLY EN FL 72H SAMPLE SER EN PO OMNIMATE EN PO OMNIMATE EN
White paper surface mount technology	Download Whitepaper

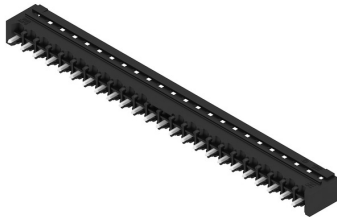
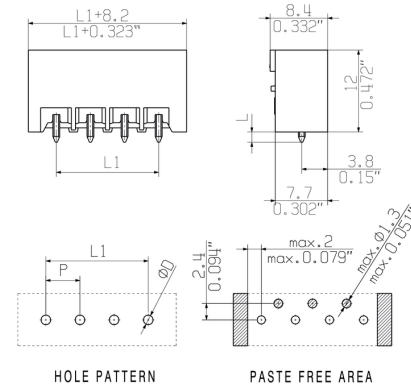
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Catalogue status 26.04.2025 / We reserve the right to make technical changes.

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Drawings**Product image****Dimensional drawing****Product benefits**

Safe power transmission
Proven properties

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Accessories

Additional accessories



No task is too small when creating the perfect solution. br />

Connections form just one part of the overall process. Small details are often the key to the perfect solution in applications where potentials are tested, grouped or even isolated.

A system is not a system without small but useful details:

- Test plugs - ensure reliable pick-up from diagnostic sockets
- Cross-connectors - ensure a stable electrical distribution contact directly at the connection
- Compartment partition elements - divide a large number of male connectors into several separate socket connector channels
- Locks and clips - optional vibration-resistant clip-on connection or mounting for male and female connectors

In tandem with the manufacturing process and application - more accessories = smaller workload

General ordering data

Type	SL AT SW	Version	Product data	Packaging
Order No.	1770240000	PCB plug-in connector, Accessories, Spacer, black, Number of poles: 1		Box
GTIN (EAN)	4032248117710			
Qty.	100 pc(s).			
Type	SL AT OR	Version	Product data	Packaging
Order No.	1598300000	PCB plug-in connector, Accessories, Spacer, orange, Number of poles: 1		Box
GTIN (EAN)	4008190189266			
Qty.	100 pc(s).			

Coding elements



Only connects what is supposed to be connected: the right connection at the right place.

Coding elements and locking devices clearly assign connecting elements during the manufacturing process and operation

The coding elements and locking devices are inserted prior to assembly or during the cable assembly phase. The Weidmüller alternative: configure online using the variant configurator to precode prior to delivery.

Incorrect assembly on the circuit board and incorrect plugging of connecting elements is no longer possible. The advantage: no troubleshooting during manufacture and no operational errors by the user.

General ordering data

Type	BLZ/SL KO OR BX	Version	Product data	Packaging
Order No.	1573010000	PCB plug-in connector, Accessories, Coding element, orange, Number of poles: 1		Box
GTIN (EAN)	4008190048396			
Qty.	100 pc(s).			

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www.weidmueller.com**Accessories**

Type	BLZ/SL KO BK BX	Version	Product data	Packaging
Order No.	1545710000	PCB plug-in connector, Accessories, Coding element, black, Number		Box
GTIN (EAN)	4008190087142	of poles: 1		
Qty.	50 pc(s).			

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Drawings

Product benefits



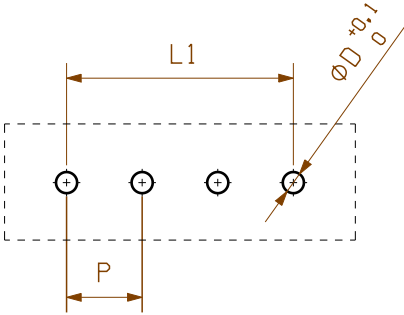
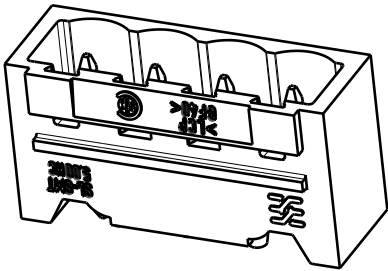
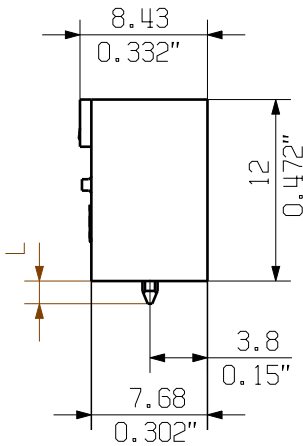
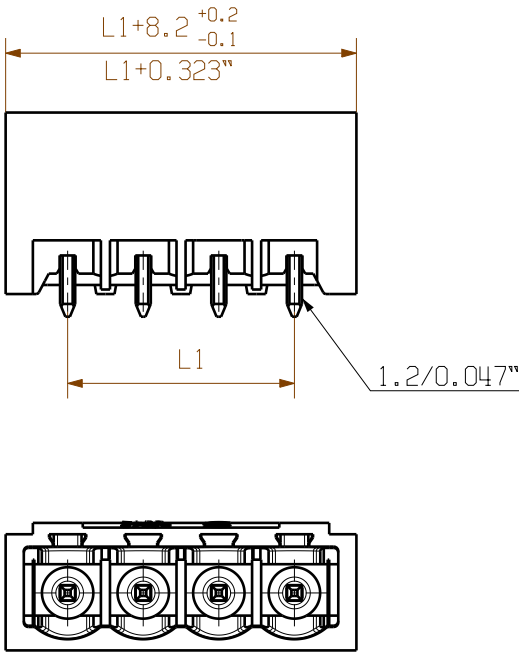
Compliant with existing standards

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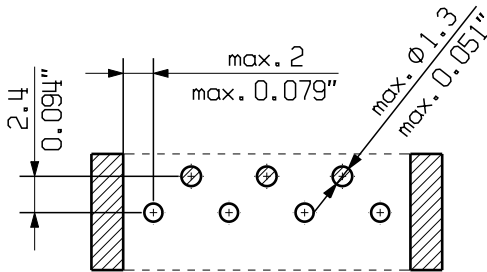
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Dimensions without tolerances are no check dimensions

The English version is binding



HOLE PATTERN



PASTE FREE AREA

D = 1.4/0.055" or 1.5/0.059" (REFLOW SOLDERING)
RECOMMENDATION FOR AUTOMATIC ASSEMBLY
(1.4 mm FOR n=2...8 / 1.5 mm for n=9...24)

P = RASTER/PITCH

SHOWN: SL-SMT 5.00HC/04/180 G

STIFTLAENGE L	TOLERANZ		
1,5	0,0	5	20,00
	-0,3	4	15,00
3,2	0,1	3	10,00
	-0,3	2	5,00
n	L1 [mm]	L1 [Inch]	

24	115,00	4,528
23	110,00	4,331
22	105,00	4,134
21	100,00	3,937
20	95,00	3,740
19	90,00	3,543
18	85,00	3,346
17	80,00	3,150
16	75,00	2,953
15	70,00	2,756
14	65,00	2,559
13	60,00	2,362
12	55,00	2,165
11	50,00	1,969
10	45,00	1,772
9	40,00	1,575
8	35,00	1,378
7	30,00	1,181
6	25,00	0,984

For the mounting of PCBs, it should be noted that the rated data stated here relates only to the PCB components alone.
The necessary creepage and clearance paths must be observed in connection with the respective applicant in accordance to IEC 664 / VDE 0110.
The current-carrying capacity and pitch tolerance is to be determined according to DIN IEC 326 part 3 very fine.

Weidmüller PCB components are tested to the DIN EN 61984 standard, and are valid for its field of application.
Provided that the components are used to the intended purpose, all requirements with respect to the occurring of electrical, mechanical, thermic and corrosive stress will be satisfied.

DIN ISO 2768-m

106340/4

30.07.18 HERTEL_S

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Modification

Date

Name

Drawn

22.01.2008

HERTEL_S

Responsible

HERTEL_S

Checked

27.08.2018

HERTEL_S

Supersedes: .

Approved

LANG_T

Weidmüller

Cat.no.: .

C 34165

07

Drawing no.

Issue no.

Sheet 02

of 04

sheets

SL-SMT 5.00HC/.../180...

STIFTELEISTE

PIN HEADER

Product file: SL-SMT 5.00

7279

Recommended wave soldering profiles

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Single Wave:



Double Wave:



Wave soldering profiles

Wired connection elements should be processed in accordance with the DIN EN 61760-1 standard. We have included two recommendations for practical wave soldering profiles, with which Weidmüller PCB terminals and connectors are qualified.

When choosing a suitable profile for your application, the following factors also need to be considered:

- PCB thickness
- Proportion of Cu in the layers
- Single/double-sided assembly
- Product range
- Heating and cooling rates

The single and double wave profiles each indicate the recommended operating range, including the maximum soldering temperature of 260°C. In practice, the maximum soldering temperature is quite often well below the above maximum profile.

We reserve the right to make technical changes.

Recommended reflow soldering profile

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Reflow soldering profile

The perfect soldering profile for SMT Surface Mount Technology is one the most exiting question in SMT production. But there are more than one correct answer: The diagram of temperature-on-time is related to processing features of solder paste and to maximum load of components.

We have to consider the following parameters:

- Time for pre heating
- Maximum temperature
- Time above melting point
- Time for cooling
- Maximum heating rate
- Maximum cooling rate

We recommend a typical solder profile with associated process limits. With preheating components and board are prepared smoothly for the solder phase. Heating rate is typically $\leq +3\text{K/s}$. In parallel the solder paste is 'activated'. The time above melting point of 217°C the paste gets liquid and components and boards begin to connect. The maximum temperature of 245°C to 254°C should stay between 10 and 40 seconds. In the cooling phase at $\geq -6\text{K/s}$ solder is cured. Board and components cool down while avoiding cold cracks.